

EAST Search History

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|-------|------|---|--|------------------|---------|------------------|
| L1 | 6 | electrode with (die chip "IC") with ("UBM" under adj bump mettallurgy) same printing same reflow\$3 | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/11/19 16:54 |
| L2 | 2682 | "LCD" with packag\$3 | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/11/19 16:55 |
| L3 | 195 | "LCD" with packag\$3 with electrode | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/11/19 17:50 |
| L4 | 52 | "LCD" with packag\$3 with electrode with print\$4 | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/11/19 16:57 |
| L5 | 0 | "LCD" with packag\$3 with electrode same print\$4 same reflow\$3 | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/11/19 16:56 |
| L6 | 0 | "LCD" with packag\$3 with electrode same print\$4 same "UBM" | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/11/19 16:56 |
| L7 | 0 | "LCD" with packag\$3 with electrode same "UBM" | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/11/19 16:57 |

EAST Search History

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| L8 | 195 | "LCD" with packag\$3 with electrode | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/11/19 17:10 |
| L9 | 0 | "LCD" with packag\$3 with electrode with reflow\$3 | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/11/19 16:57 |
| L12 | 120 | electrode with (die chip "IC") with ("UBM" under adj bump mettallurgy) | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/11/19 17:34 |
| L13 | 120 | electrode with (die chip "IC") with ("UBM" under adj bump mettallurgy) | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/11/19 17:34 |
| L14 | 1 | 10/711280 | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/11/19 17:49 |
| L18 | 2 | (bumping ADJ process WITH ((LIGHT ADJ EMITTING ADJ DIODE LED) ADJ device) AND (SUBSTRATE WORKPIECE wafer) WITH electrodes AND (UBM under ADJ bump ADJ metallurgy) NEAR3 layer WITH posts WITH printing ADJ process AND reflowing WITH posts).CLM. | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/11/19 17:55 |
| S1 | 21 | "6293456" | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/06/20 06:09 |

EAST Search History

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| S2 | 36 | "6179200" | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/06/20 06:17 |
| S3 | 0 | "10711280" | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/11/19 11:10 |
| S4 | 1 | 10/711280 | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2007/06/20 06:17 |